

VMDSEMI

VUSK002R26ANA

Datasheet

General Description

Symbol

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	I_D
20V	260mΩ@4.5V	0.75A
	360mΩ@2.5V	
	590mΩ@1.8V	

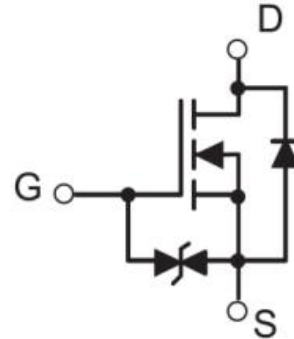
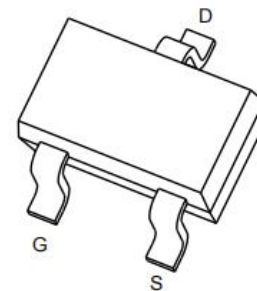


Figure 1 Symbol of VUSK002R26ANA

Features

- Excellent $R_{DS(on)}$ and Low Gate Charge
- Trench FET Power MOSFET
- ESD Protected

Package Type



SOT-523

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Small Portable Electronics
- Level shift

Figure 2 Package Type of VUSK002R26ANA

Ordering Information

Product Name	Package
VUSK002R26ANA	SOT-523

Absolute Maximum Ratings ($T_A=25\text{ }^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	20	V
Gate-Source Voltage	V_{GSS}	± 12	V
Continuous Drain Current	I_D	0.75	A
Pulsed Drain Current ^{Note1} ($t=300\mu\text{s}$)	I_{DM}	3	A
Total Power Dissipation ^{Note2}	P_D	0.15	W
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient ^{Note1}	$R_{\theta JA}$		653		$^\circ\text{C}/\text{W}$

Electrical Characteristics ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=20V, V_{GS}=0V$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 10V, V_{DS}=0V$			± 20	μA
Gate Threshold Voltage ^{Note3}	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.35	0.75	1.1	V
Drain-source on-resistance ^{Note3}	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=0.65A$		190	260	
		$V_{GS}=2.5V, I_D=0.55A$		260	360	
		$V_{GS}=1.8V, I_D=0.45A$		390	590	
Forward tranconductance ^{Note3}	g_{FS}	$V_{DS}=10V, I_D=0.8A$		0.9		S
Dynamic Characteristics						
Input Capacitance	C_{ISS}	$V_{DS}=16V$			120	pF
Output Capacitance	C_{OSS}	$V_{GS}=0V$			20	pF
Reverse Transfer Capacitance	C_{RSS}	$f=1MHz$			15	pF
Switching Parameters						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V$		6.7		ns
Turn-on Rise Time	t_r	$V_{GEN}=4.5V$		4.8		
Turn-off Delay Time	$t_{d(off)}$	$I_D=0.5A$		17.3		
Turn-off Fall Time	t_f	$R_{GEN}=10\Omega$		7.4		
Diode Characteristics						
Diode Forward Voltage ^{Note3}	V_{SD}	$V_{GS}=0V, I_S=0.15A$			1.2	V

Notes :

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at $T_A=25C$.
3. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 0.5\%$.

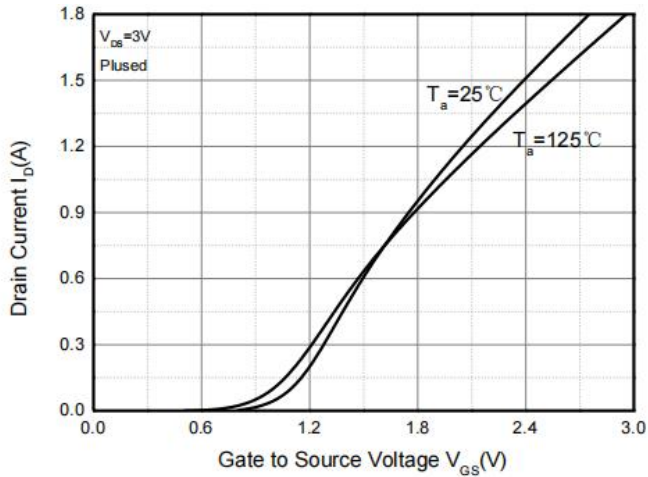
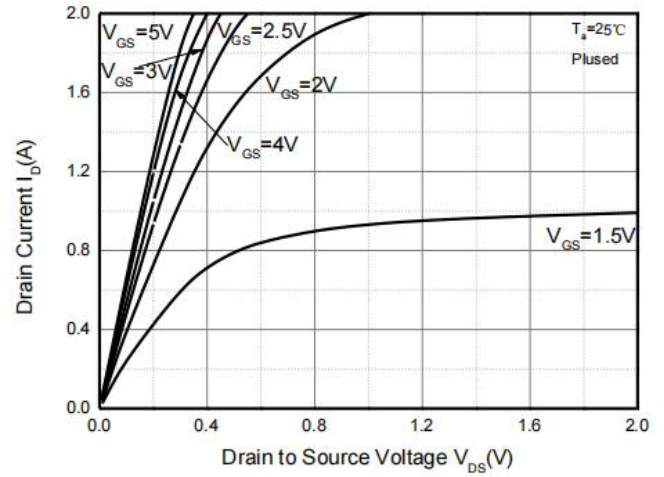
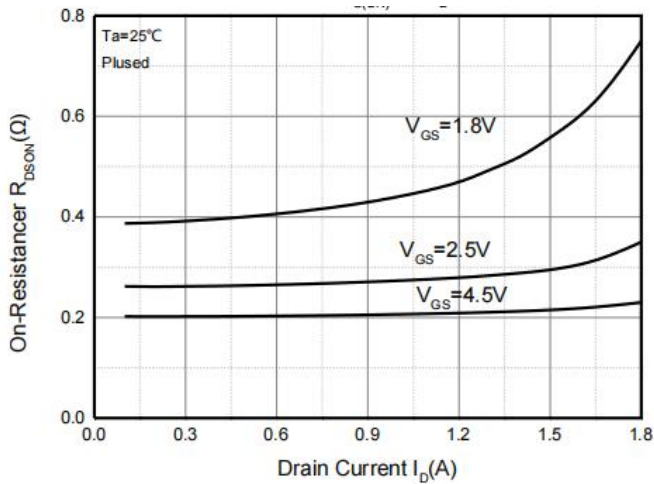
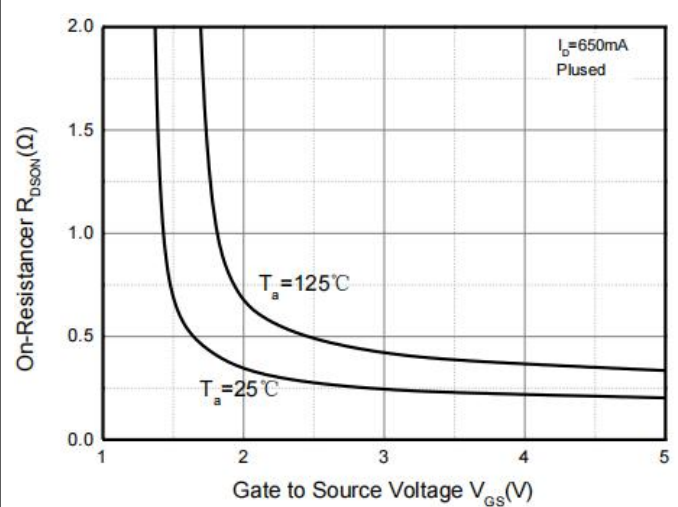
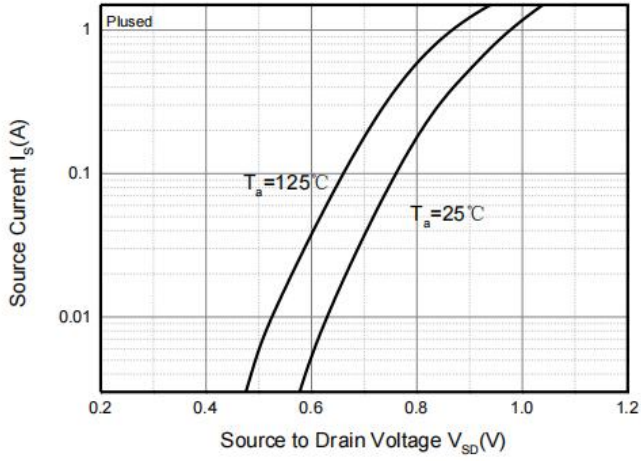
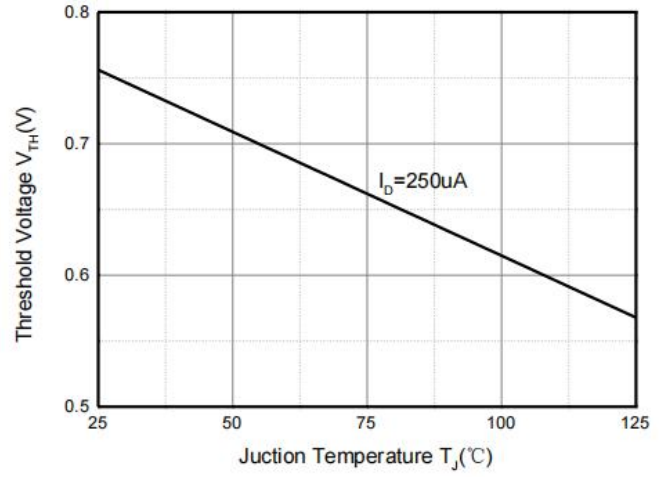
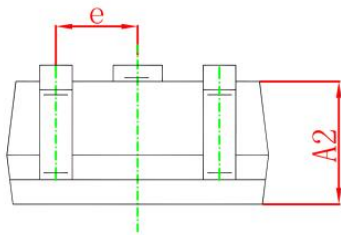
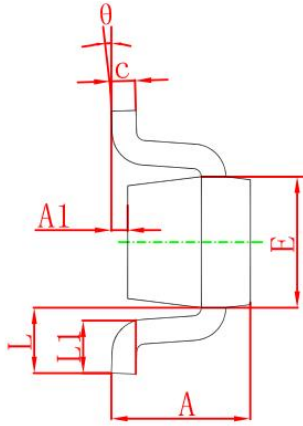
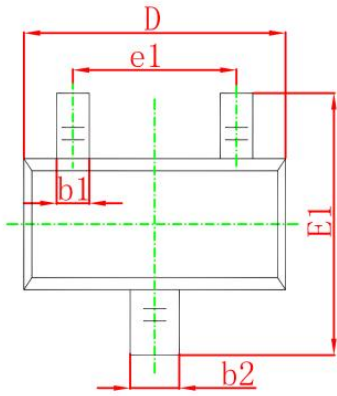
Typical Performance Characteristics
Figure 3: Transfer Characteristics

Figure 4: Output Characteristics

Figure 5: On-Resistance vs. Drain Current

Figure 6: On-Resistance vs. Gate Voltage


Figure 7: Body Diode Characteristics

Figure 8: Threshold Voltage


Mechanical Dimensions:
SOT-523 Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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